

Based Material Line Up



S1600L/S1600LB

1. CORE (C-STAGE)

Thickness		ply-up	RC (%)	Dk		Df	
mm	mil			1 MHz	1 GHz	1 MHz	1 GHz
0.40	15.75	2x7628	47%	5.1	4.7	0.0180	0.0142
0.46	18.11	1x1080+2x7628	51%	5.1	4.6	0.0190	0.0148
0.48	18.90	1x2116+2x7628	47%	5.1	4.6	0.0182	0.0143
0.50	19.69	1x2116+2x7628	49%	5.1	4.6	0.0186	0.0146
0.56	22.05	3x7628	46%	5.1	4.7	0.0178	0.0141
0.60	23.62	3x7628	47%	5.1	4.7	0.0180	0.0142
0.64	25.20	2x2116+2x7628	51%	5.1	4.6	0.0190	0.0148
0.66	25.98	4x2116+1x7628	52%	5.1	4.6	0.0195	0.0149
0.71	27.95	4x7628	43%	5.3	4.7	0.0172	0.0138
0.76	29.92	4x7628	45%	5.2	4.7	0.0175	0.0139
0.80	31.50	4x7628	47%	5.1	4.7	0.0180	0.0142
0.90	35.43	1x2116+4x7628	47%	5.1	4.6	0.0182	0.0143
1.00	39.37	5x7628	47%	5.1	4.7	0.0180	0.0142
1.20	47.24	6x7628	47%	5.1	4.7	0.0180	0.0142
1.40	55.12	7x7628	47%	5.1	4.7	0.0180	0.0142
1.50	59.06	8x7628	46%	5.1	4.7	0.0177	0.0140
1.60	62.99	9x7628	44%	5.2	4.7	0.0173	0.0138

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2. PREPREG (B-STAGE)

Glass s Style	RC (%) Nominal	Thickness		DK		Df	
		mm	mil	1 MHz	1 GHz	1 MHz	1 GHz
7628	46	0.190	7.48	5.1	4.7	0.0177	0.0140
7628	48	0.200	7.87	5.1	4.6	0.0183	0.0144
7628	50	0.210	8.27	5.1	4.6	0.0189	0.0147
2116	52	0.110	4.33	5.1	4.6	0.0195	0.0149
2116	55	0.120	4.72	5.0	4.5	0.0204	0.0152
2116	58	0.130	5.12	5.0	4.5	0.0213	0.0155

3. REMARK

- 1) Test by IPC TM-650 2.5.5.9 parallel plate method.
- 2) The data above show actual values and are not guaranteed, for your reference only.
- 3) Last update: June, 2020